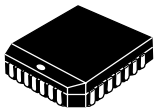
MC10E137, MC100E137

5 V ECL 8-Bit Ripple Counter

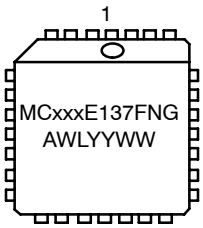
ON Semiconductor®

http://onsemi.com



PLCC−28
FN SUFFIX
CASE 776

MARKING DIAGRAM*



xxx	= 10 or 100
A	= Assembly Location
WL	= Wafer Lot
YY	= Year
WW	= Work Week
G	= Pb−Free Package

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

Description

The MC10E/100E137 is a very high speed binary ripple counter. The two least significant bits were designed with very fast edge rates while the more significant bits maintain standard ECLinPS™ output edge rates. This allows the counter to operate at very high frequencies while maintaining a moderate power dissipation level.

The device is ideally suited for multiple frequency clock generation as well as a counter in a high performance ATE time measurement board.

Both asynchronous and synchronous enables are available to maximize the device's flexibility for various applications. The asynchronous enable input, A_Start, when asserted enables the counter while overriding any synchronous enable signals. The E137 features XORed enable inputs, EN1 and EN2, which are synchronous to the CLK input. When only one synchronous enable is asserted the counter becomes disabled on the next CLK transition; all outputs remain in the previous state poised for the other synchronous enable or A_Start to be asserted to re-enable the counter. Asserting both synchronous enables causes the counter to become enabled on the next transition of the CLK. If EN1 (or EN2) and CLK edges are coincident, sufficient delay has been inserted in the CLK path (to compensate for the XOR gate delay and the internal D-flip flop setup time) to insure that the synchronous enable signal is clocked correctly, hence, the counter is disabled.

All input pins left open will be pulled LOW via an input pulldown resistor. Therefore, do not leave the differential CLK inputs open. Doing so causes the current source transistor of the input clock gate to become saturated, thus upsetting the internal bias regulators and jeopardizing the stability of the device.

The asynchronous Master Reset resets the counter to an all zero state upon assertion.

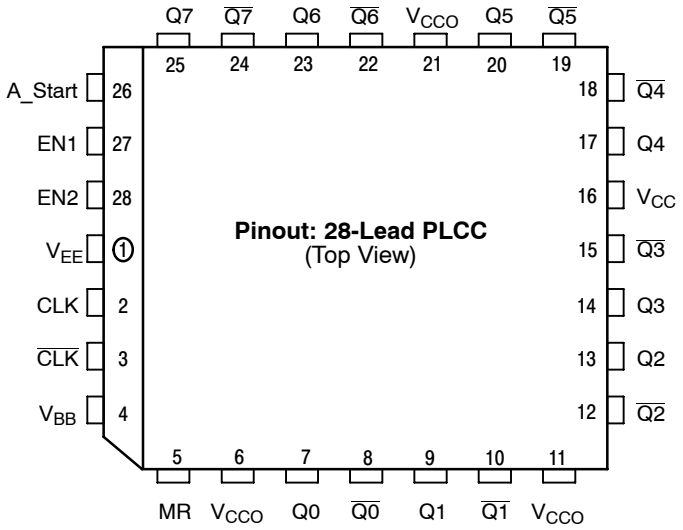
The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 μF capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

The 100 Series contains temperature compensation.

Features

- Differential Clock Input and Data Output Pins
- V_{BB} Output for Single-Ended Use
- Synchronous and Asynchronous Enable Pins
- Asynchronous Master Reset
- PECL Mode Operating Range: V_{CC} = 4.2 V to 5.7 V with V_{EE} = 0 V
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = −4.2 V to −5.7 V
- Internal Input 50 kΩ Pull−down Resistors
- Transistor Count = 330 devices
- ESD Protection: Human Body Model: > 2 kV, Machine Model: > 200 V
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level: Pb = 1; Pb−Free = 3 For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL 94 V−0 @ 0.125 in, Oxygen Index: 28 to 34
- Pb−Free Packages are Available*

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



* All V_{CC} and V_{CCO} pins are tied together on the die.

Warning: All V_{CC}, V_{CCO}, and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. 28−Lead Pinout

Table 1. PIN DESCRIPTION

PIN	FUNCTION
CLK, $\overline{CLK}$	ECL Differential Clock Inputs
Q0-Q7, $\overline{Q0}$-$\overline{Q7}$	ECL Differential Q Outputs
A_Start	ECL Asynchronous Enable Input
EN1, EN2	ECL Synchronous Enable Inputs
MR	Asynchronous Master Reset
V_{BB}	Reference Voltage Output
V_{CC}, V_{CCO}	Positive Supply
V_{EE}	Negative Supply

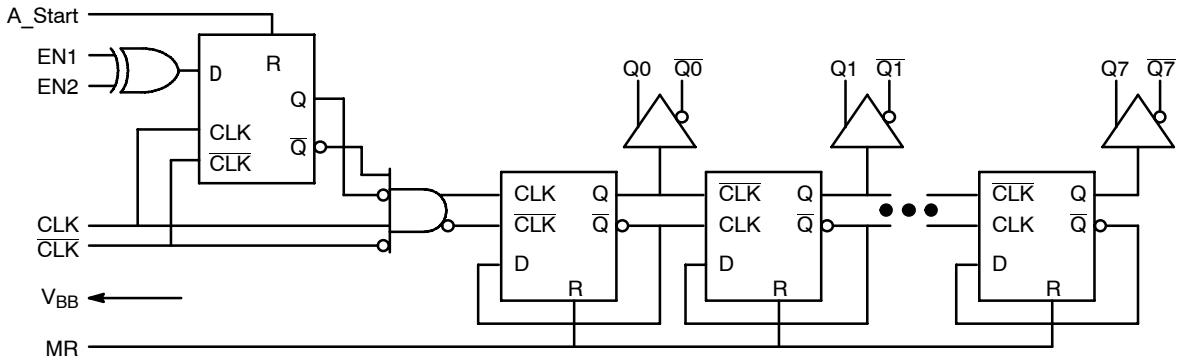


Figure 2. Logic Diagram

Table 2. SEQUENTIAL TRUTH TABLE

Function	EN1	EN2	A_Start	MR	CLK	Q7	Q6	Q5	Q4	Q3	Q2	Q1	Q0
Reset	X	X	X	H	X	L	L	L	L	L	L	L	L
Count	L	L	L	L	Z	L	L	L	L	L	L	L	H
	L	L	L	L	Z	L	L	L	L	L	L	H	L
	L	L	L	L	Z	L	L	L	L	L	L	H	H
Stop	H	L	L	L	Z	L	L	L	L	L	L	H	H
	H	L	L	L	Z	L	L	L	L	L	L	H	H
Asynch Start	H	L	H	L	Z	L	L	L	L	L	H	L	L
	H	L	H	L	Z	L	L	L	L	L	H	L	H
	L	L	H	L	Z	L	L	L	L	L	H	H	L
Count	L	L	L	L	Z	L	L	L	L	L	H	H	H
	L	L	L	L	Z	L	L	L	L	H	L	L	L
	L	L	L	L	Z	L	L	L	L	H	L	L	H
Stop	L	H	L	L	Z	L	L	L	L	H	L	L	H
	L	H	L	L	Z	L	L	L	L	H	L	L	H
Synch Start	H	H	L	L	Z	L	L	L	L	H	L	H	L
	H	H	L	L	Z	L	L	L	L	H	L	H	H
	H	H	L	L	Z	L	L	L	L	H	H	L	L
Stop	H	L	L	L	Z	L	L	L	L	H	H	L	L
	H	L	L	L	Z	L	L	L	L	H	H	L	L
Count	L	L	L	L	Z	L	L	L	L	H	H	L	H
	L	L	L	L	Z	L	L	L	L	H	H	H	L
	L	L	L	L	Z	L	L	L	L	H	H	H	H
Reset	X	X	X	H	X	L	L	L	L	L	L	L	L

Z = Low to High Transition

Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V_{CC}	PECL Mode Power Supply	V_{EE} = 0 V		8	V
V_{EE}	NECL Mode Power Supply	V_{CC} = 0 V		−8	V
V_I	PECL Mode Input Voltage	V_{EE} = 0 V	$V_I \le V_{CC}$	6	V
	NECL Mode Input Voltage	V_{CC} = 0 V	$V_I \ge V_{EE}$	−6	V
I_{out}	Output Current	Continuous		50	mA
		Surge		100	mA
T_A	Operating Temperature Range			0 to +85	°C
T_{stg}	Storage Temperature Range			−65 to +150	°C
θ_{JA}	Thermal Resistance (Junction−to−Ambient)	0 lfpm	PLCC−28	63.5	°C/W
		500 lfpm	PLCC−28	43.5	°C/W
θ_{JC}	Thermal Resistance (Junction−to−Case)	Standard Board	PLCC−28	22 to 26	°C/W
V_{EE}	PECL Operating Range			4.2 to 5.7	V
	NECL Operating Range			−5.7 to −4.2	V
T_{sol}	Wave Solder Pb			265	°C
	Wave Solder Pb−Free			265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. 10E SERIES PECL DC CHARACTERISTICS V_{CCx} = 5.0 V; V_{EE} = 0.0 V (Note 1)

		0°C			25°C			85°C			
Symbol	Characteristic	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit
I_{EE}	Power Supply Current		121	145		121	145		121	145	mA
V_{OH}	Output HIGH Voltage (Note 2)	3980	40 70	4160	4020	4105	4190	4090	4185	4280	mV
V_{OL}	Output LOW Voltage (Note 2)	3050	3210	3370	3050	3210	3370	3050	3227	3405	mV
V_{IH}	Input HIGH Voltage (Single−Ended)	3830	3995	4160	3870	4030	4190	3940	4110	4280	mV
V_{IL}	Input LOW Voltage (Single−Ended)	3050	3285	3520	3050	3285	3520	3050	3302	3555	mV
V_{BB}	Output Voltage Reference	3.62		3.73	3.65		3.75	3.69		3.81	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 3)	2.2		4.6	2.2		4.6	2.2		4.6	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5	0.3		0.5	0.25		0.3	0.2		μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary −0.46 V / +0.06 V.
2. Outputs are terminated through a 50 Ω resistor to V_{CC} − 2.0 V.
3. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}.

Table 5. 10E SERIES NECL DC CHARACTERISTICS V_{CCx} = 0.0 V; V_{EE} = −5.0 V (Note 4)

		0°C			25°C			85°C			
Symbol	Characteristic	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit
I_{EE}	Power Supply Current		121	145		121	145		121	145	mA
V_{OH}	Output HIGH Voltage (Note 5)	−1020	−930	−840	−980	−895	−810	−910	−815	−720	mV
V_{OL}	Output LOW Voltage (Note 5)	−1950	−1790	−1630	−1950	−1790	−1630	−1950	−1773	−1595	mV
V_{IH}	Input HIGH Voltage (Single−Ended)	−1170	−1005	−840	−1130	−970	−810	−1060	−890	−720	mV
V_{IL}	Input LOW Voltage (Single−Ended)	−1950	−1715	−1480	−1950	−1715	−1480	−1950	−1698	−1445	mV
V_{BB}	Output Voltage Reference	−1.38		−1.27	−1.35		−1.25	−1.31		−1.19	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 6)	−2.8		−0.4	−2.8		−0.4	−2.8		−0.4	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5	0.3		0.5	0.065		0.3	0.2		μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

4. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary −0.46 V / +0.06 V.
5. Outputs are terminated through a 50 Ω resistor to V_{CC} − 2.0 V.
6. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}.

Table 6. 100E SERIES PECL DC CHARACTERISTICS V_{CCx} = 5.0 V; V_{EE} = 0.0 V (Note 7)

Symbol	Characteristic	0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		121	145		121	145		139	167	mA
V_{OH}	Output HIGH Voltage (Note 8)	3975	4050	4120	3975	4050	4120	3975	4050	4120	mV
V_{OL}	Output LOW Voltage (Note 8)	3190	3295	3380	3190	3255	3380	3190	3260	3380	mV
V_{IH}	Input HIGH Voltage (Single−Ended)	3835	3975	4120	3835	3975	4120	3835	3975	4120	mV
V_{IL}	Input LOW Voltage (Single−Ended)	3190	3355	3525	3190	3355	3525	3190	3355	3525	mV
V_{BB}	Output Voltage Reference	3.62		3.73	3.62		3.74	3.62		3.74	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 9)	2.2		4.6	2.2		4.6	2.2		4.6	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5	0.3		0.5	0.25		0.5	0.2		μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

7. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary −0.46 V / +0.8 V.
8. Outputs are terminated through a 50 Ω resistor to V_{CC} − 2.0 V.
9. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}.

Table 7. 100E SERIES NECL DC CHARACTERISTICS V_{CCx} = 0.0 V; V_{EE} = −5.0 V (Note 10)

Symbol	Characteristic	0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		121	145		121	145		139	167	mA
V_{OH}	Output HIGH Voltage (Note 11)	−1025	−950	−880	−1025	−950	−880	−1025	−950	−880	mV
V_{OL}	Output LOW Voltage (Note 11)	−1810	−1705	−1620	−1810	−1745	−1620	−1810	−1740	−1620	mV
V_{IH}	Input HIGH Voltage (Single−Ended)	−1165	−1025	−880	−1165	−1025	−880	−1165	−1025	−880	mV
V_{IL}	Input LOW Voltage (Single−Ended)	−1810	−1645	−1475	−1810	−1645	−1475	−1810	−1645	−1475	mV
V_{BB}	Output Voltage Reference	−1.38		−1.27	−1.38		−1.26	−1.38		−1.26	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 12)	−3.8		−0.4	−3.8		−0.4	−3.8		−0.4	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5	0.3		0.5	0.25		0.5	0.2		μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

10. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary −0.46 V / +0.8 V.
11. Outputs are terminated through a 50 Ω resistor to V_{CC} − 2.0 V.
12. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}.

Table 8. AC CHARACTERISTICS V_{CCx} = 5.0 V; V_{EE} = 0.0 V or V_{CCx} = 0.0 V; V_{EE} = −5.0 V (Note 13)

Symbol	Characteristic	0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f_{COUNT}	Maximum Count Frequency	1800	2200		1800	2200		1800	2200		MHz
t_{PLH} t_{PHL}	Propagation Delay to Output										ps
	CLK to Q0	1300	1700	2150	1300	1700	2150	1350	1750	2200	
	CLK to Q1	1600	2025	2500	1600	2050	2500	1650	2100	2550	
	CLK to Q2	1950	2425	2925	1950	2450	2925	2025	2500	3000	
	CLK to Q3	2275	2750	3350	2275	2775	3350	2350	2850	3425	
	CLK to Q4	2625	3125	3750	2625	3150	3750	2700	3225	3825	
	CLK to Q5	2950	3450	4150	2950	3475	4150	3050	3550	4250	
	CLK to Q6	3250	3775	4450	3250	3800	4450	3375	3925	4600	
	CLK to Q7	3575	4075	4800	3575	4125	4800	3700	4250	4950	
	A_Start to Q0	950	1325	1700	950	1325	1700	950	1325	1700	
	MR to Q0	700	1000	1300	700	1000	1300	700	1000	1300	
t_s	Setup Time (EN1, EN2)	0	−150		0	−150		0	−150		ps
t_h	Hold Time (EN1, EN2)	300	150		300	150		300	150		ps
t_{RR}	Reset Recovery Time										ps
	MR, A_Start	400	200		400	200		400	200		
t_{PW}	Minimum Pulse Width										ps
	CLK, MR, A_Start	400			400			400			
V_{PP}	Input Voltage Swing CLK/$\overline{CLK}$ (Differential Configuration) (Note 14)	0.25		1.0	0.25		1.0	0.25		1.0	V
t_{JITTER}	Random Clock Jitter (RMS)		< 1			< 1			< 1		ps
t_r t_f	Rise/Fall Times (20%−80%)										ps
	Q0,Q1	150		400	150		400	150		400	
	Q2 to Q7	275		600	275		600	275		600	

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

13. 10 Series: V_{EE} can vary −0.46 V / +0.06 V.
    100 Series: V_{EE} can vary −0.46 V / +0.8 V.
14. Minimum input swing for which AC parameters are guaranteed. Full DC ECL output swings will be generated with only 50 mV input swings.

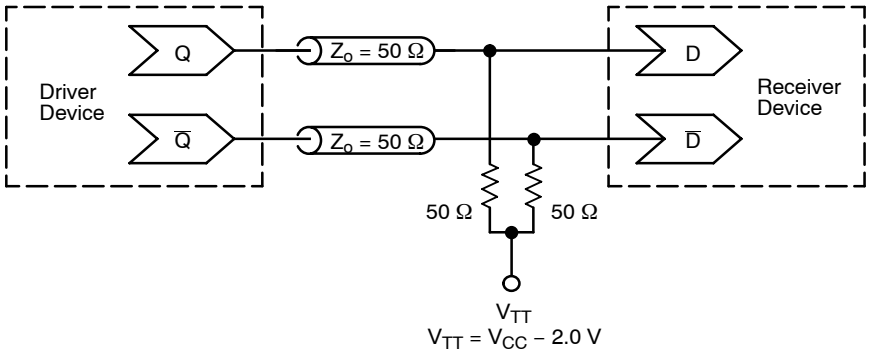


Figure 3. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

ORDERING INFORMATION

Device	Package	Shipping†
MC10E137FN	PLCC−28	37 Units / Rail
MC10E137FNG	PLCC−28 (Pb−Free)	37 Units / Rail
MC10E137FNR2	PLCC−28	500 / Tape & Reel
MC10E137FNR2G	PLCC−28 (Pb−Free)	500 / Tape & Reel
MC100E137FN	PLCC−28	37 Units / Rail
MC100E137FNG	PLCC−28 (Pb−Free)	37 Units / Rail
MC100E137FNR2	PLCC−28	500 / Tape & Reel
MC100E137FNR2G	PLCC−28 (Pb−Free)	500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D – ECL Clock Distribution Techniques

AN1406/D – Designing with PECL (ECL at +5.0 V)

AN1503/D – ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D – Metastability and the ECLinPS Family

AN1568/D – Interfacing Between LVDS and ECL

AN1672/D – The ECL Translator Guide

AND8001/D – Odd Number Counters Design

AND8002/D – Marking and Date Codes

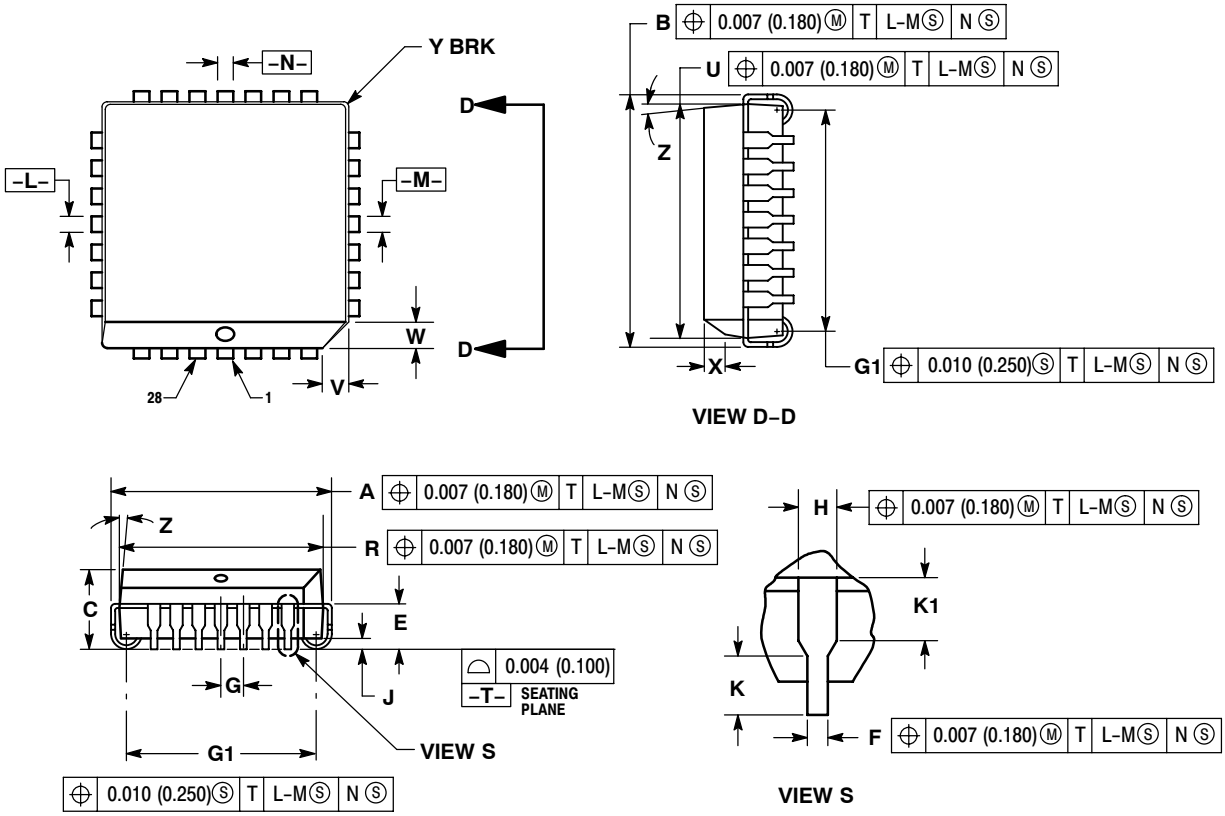
AND8020/D – Termination of ECL Logic Devices

AND8066/D – Interfacing with ECLinPS

AND8090/D – AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

PLCC−28
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 776−02
ISSUE E



NOTES:
1. DATUMS –L–, –M–, AND –N– DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM –T–, SEATING PLANE.
3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
5. CONTROLLING DIMENSION: INCH.
6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040	---	1.02	---

ECLinPS is a trademark of Semiconductor Components Industries, LLC (SCILLC).

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303−675−2175 or 800−344−3860 Toll Free USA/Canada
Fax: 303−675−2176 or 800−344−3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800−282−9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81−3−5773−3850

ON Semiconductor Website: **www.onsemi.com**

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

MC10E137/D